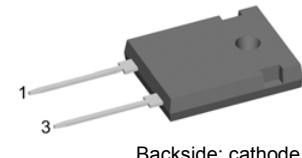
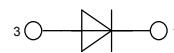


**HiPerFRED<sup>2</sup>**

High Performance Fast Recovery Diode  
Low Loss and Soft Recovery  
Single Diode

**Part number**

DPG 60 I 400 HA



Backside: cathode

**Features / Advantages:**

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low  $I_{rm}$ -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low  $I_{rm}$  reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commuting switch

**Applications:**

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

**Package:**

- Housing: TO-247
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

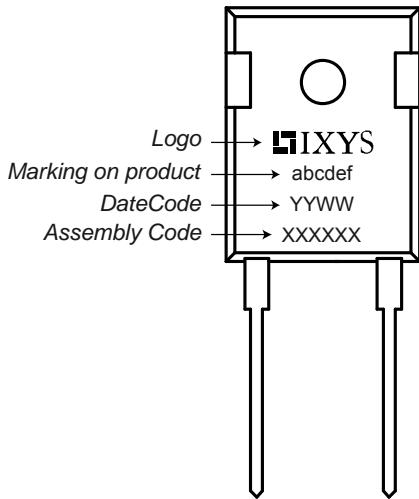
Ratings							
Symbol	Definition	Conditions		min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^\circ\text{C}$				400	V
$I_R$	reverse current	$V_R = 400\text{V}$ $T_{VJ} = 25^\circ\text{C}$			1		$\mu\text{A}$
		$V_R = 400\text{V}$ $T_{VJ} = 150^\circ\text{C}$			0.3		mA
$V_F$	forward voltage	$I_F = 60\text{A}$ $T_{VJ} = 25^\circ\text{C}$			1.47		V
		$I_F = 120\text{A}$			1.80		V
		$I_F = 60\text{A}$ $T_{VJ} = 150^\circ\text{C}$			1.22		V
		$I_F = 120\text{A}$			1.59		V
$I_{FAV}$	average forward current	rectangular	$d = 0.5$	$T_C = 120^\circ\text{C}$		60	A
$V_{FO}$	threshold voltage	$T_{VJ} = 175^\circ\text{C}$			0.81		V
		$r_F$ slope resistance } for power loss calculation only			6.1		$\text{m}\Omega$
$R_{thJC}$	thermal resistance junction to case				0.55		K/W
$T_{VJ}$	virtual junction temperature			-55	175		$^\circ\text{C}$
$P_{tot}$	total power dissipation			$T_C = 25^\circ\text{C}$		275	W
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}$ (50 Hz), sine		$T_{VJ} = 45^\circ\text{C}$		450	A
$I_{RM}$	max. reverse recovery current	$T_{VJ} = 25^\circ\text{C}$			4		A
		$I_F = 60\text{A}; V_R = 270\text{V}$ $T_{VJ} = 125^\circ\text{C}$			9.5		A
$t_{rr}$	reverse recovery time	$-di_F/dt = 200\text{ A}/\mu\text{s}$		$T_{VJ} = 25^\circ\text{C}$	45		ns
		$T_{VJ} = 125^\circ\text{C}$			85		ns
$C_J$	junction capacitance	$V_R = 200\text{V}; f = 1\text{ MHz}$		$T_{VJ} = 25^\circ\text{C}$	61		pF

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin <sup>1)</sup>			70	A
$R_{thCH}$	thermal resistance case to heatsink			0.25		K/W
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				6		g
$M_D$	mounting torque		0.8		1.2	Nm
$F_c$	mounting force with clip		20		120	N

<sup>1)</sup>  $I_{RMS}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

### Product Marking



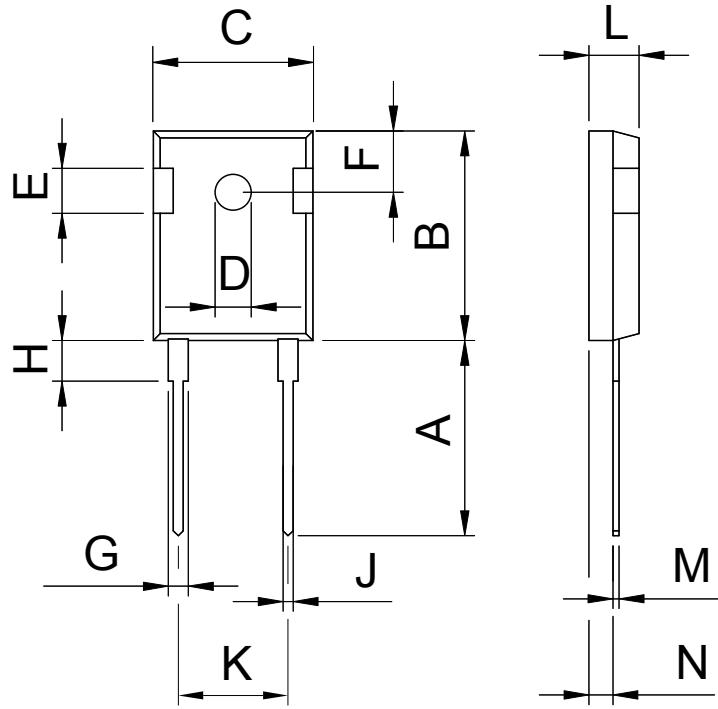
### Part number

D = Diode  
 P = HiPerFRED  
 G = extreme fast  
 60 = Current Rating [A]  
 I = Single Diode  
 400 = Reverse Voltage [V]  
 HA = TO-247AD (2)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DPG 60 I 400 HA	DPG60I400HA	Tube	30	506242

Similar Part	Package	Voltage Class
DPG60IM400QB	TO-3P (3)	400

## Outlines TO-247



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	19.81	20.32	0.780	0.800
B	20.80	21.46	0.819	0.845
C	15.75	16.26	0.610	0.640
D	3.55	3.65	0.140	0.144
E	4.32	5.49	0.170	0.216
F	5.4	6.2	0.212	0.244
G	1.65	2.13	0.065	0.084
H	-	4.5	-	0.177
J	1.0	1.4	0.040	0.055
K	10.8	11.0	0.426	0.433
L	4.7	5.3	0.185	0.209
M	0.4	0.8	0.016	0.031
N	1.5	2.49	0.087	0.102

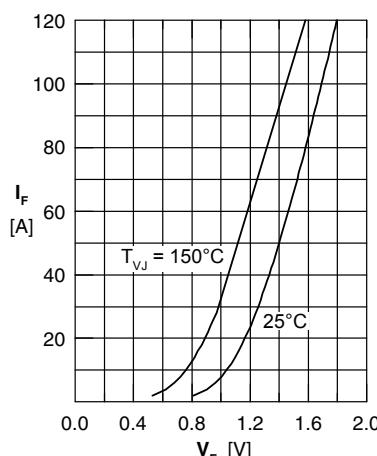


Fig. 1 Forward current  $I_F$  versus forward voltage  $V_F$

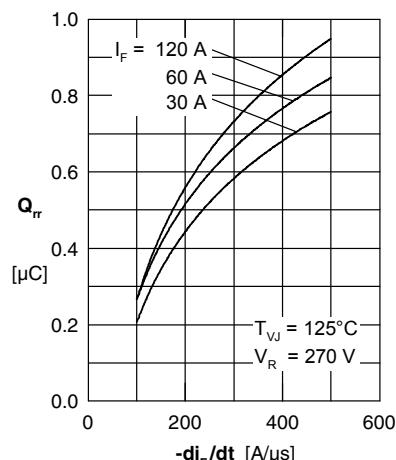


Fig. 2 Typ. reverse recovery charge  $Q_{rr}$  versus  $-di_F/dt$

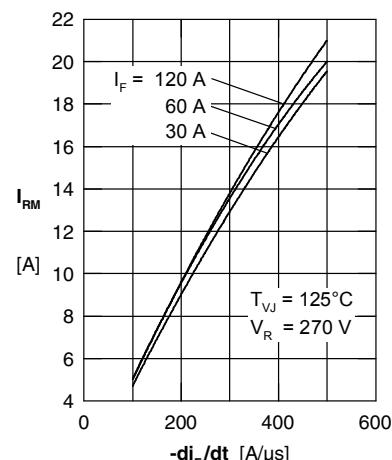


Fig. 3 Typ. reverse recovery current  $I_{RM}$  versus  $-di_F/dt$

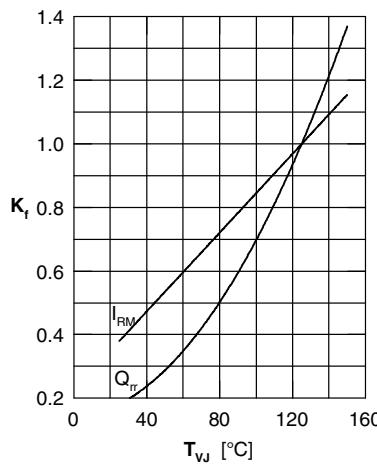


Fig. 4 Dynamic parameters  $Q_{rr}$ ,  $I_{RM}$  versus  $T_{VJ}$

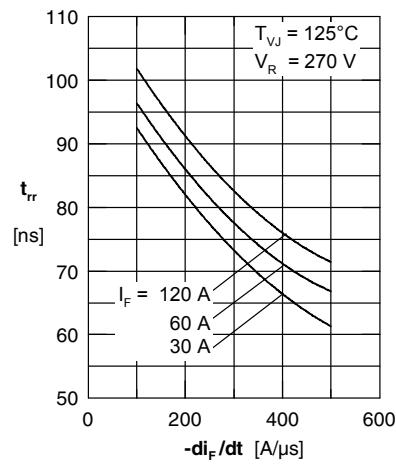


Fig. 5 Typ. reverse recovery time  $t_{rr}$  versus  $-di_F/dt$

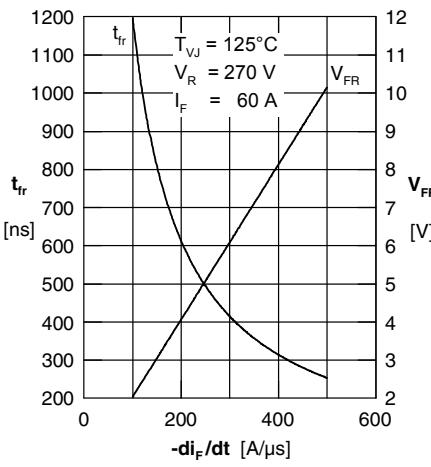


Fig. 6 Typ. forward recovery voltage  $V_{FR}$  & forward recovery time  $t_{fr}$  vs.  $di_F/dt$

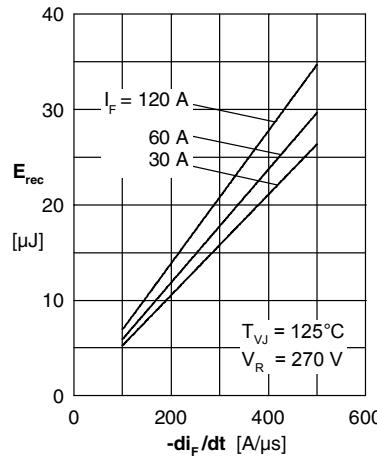


Fig. 7 Typ. recovery energy  $E_{rec}$  versus  $-di_F/dt$

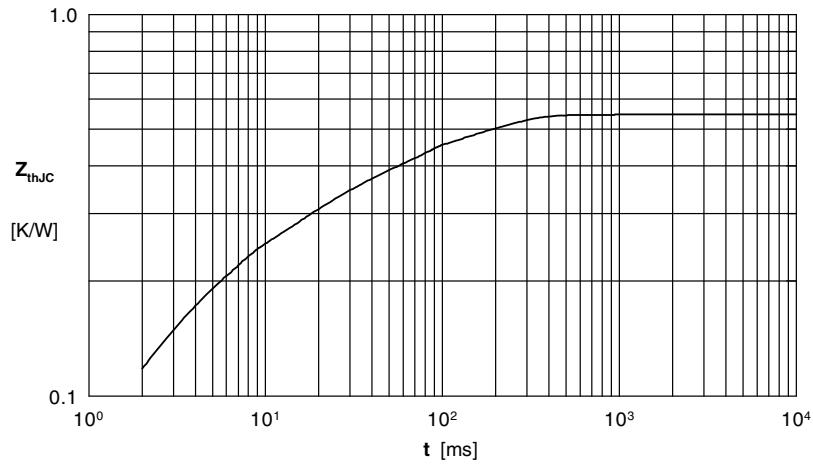


Fig. 8 Transient thermal impedance junction to case